
RL78/G13

R01AN1514EG0100

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Jun 7, 2013

Utilising the DMAC (Using GNURL78 v13.01 Toolchain)

Introduction

The purpose of this Application Note is to show the user how to add the associated RL78G13 sample code to a new or existing e²studio workspace; as well as give an explanation of what the sample code does.

The sample code provided with this Application Note demonstrates usage of the Direct Memory Access Controller. The program runs on the RL78G13 RSK and configures the DMAC to perform data transfer from one source to multiple destinations. The data source is the Serial Array Unit's (SAU) transmit buffer. The destination is a block of memory space in the range of 0xFFA00 — 0xFFBFF which is filled with string "Renesas RL78G13".

Target Device

RL78G13

Contents

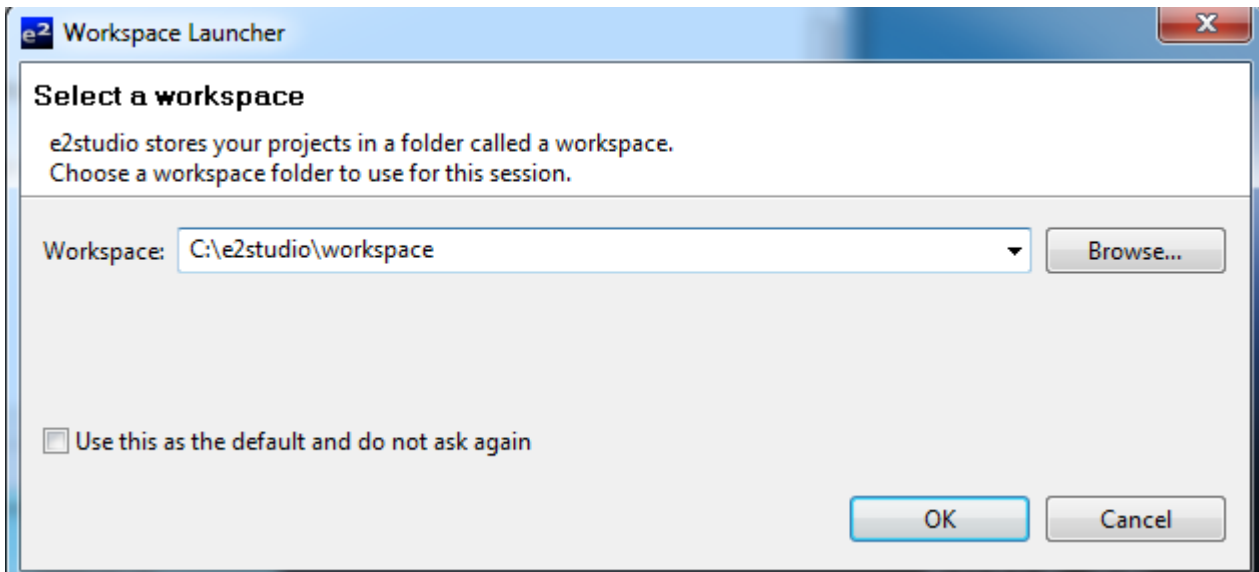
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1. Installation

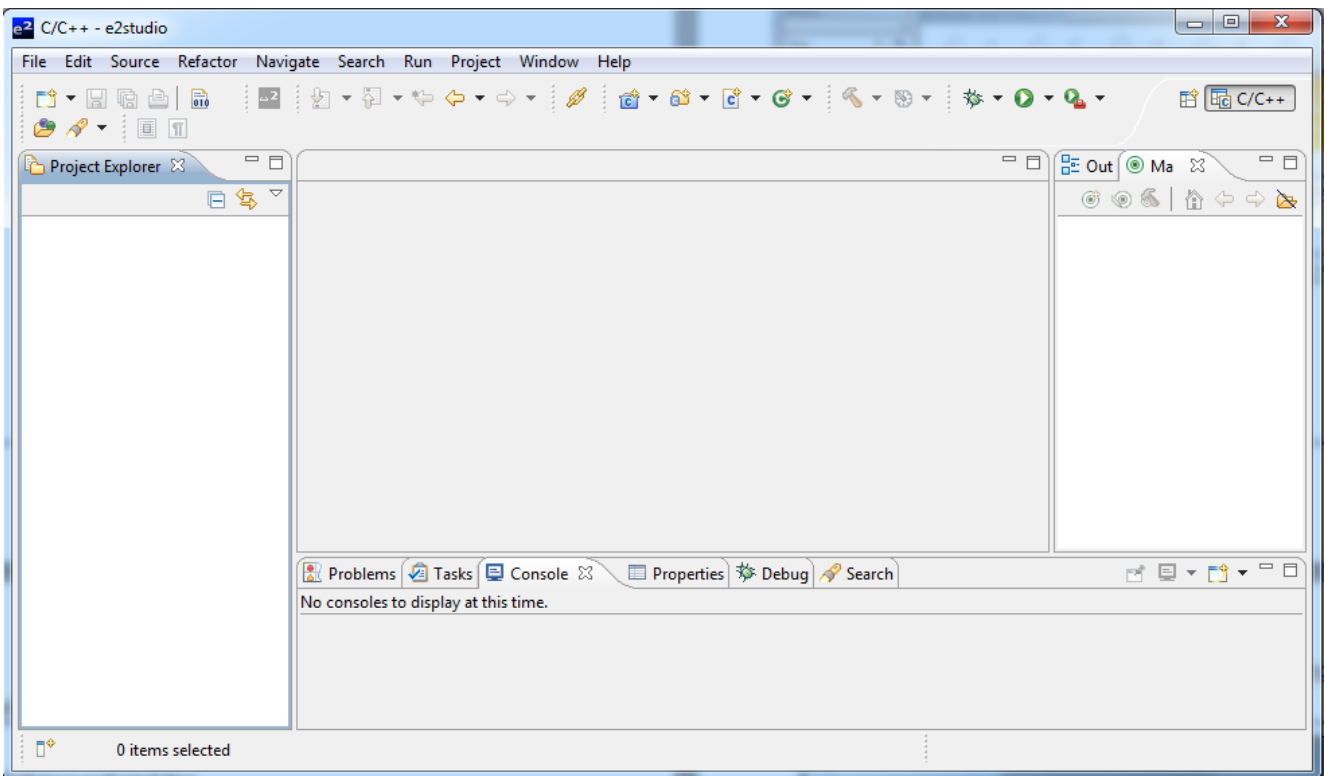
This section assumes e²studio is already installed on the user's personal computer (PC). Create a new folder and name it as 'RSKRL78G13_Workspace'. Copy the zipped file DMAC.zip, available in the Application Note package downloaded from the website, to this folder. Extract the DMAC.zip file to the RSKRL78G13_Workspace folder.

2. Creating the Project Workspace

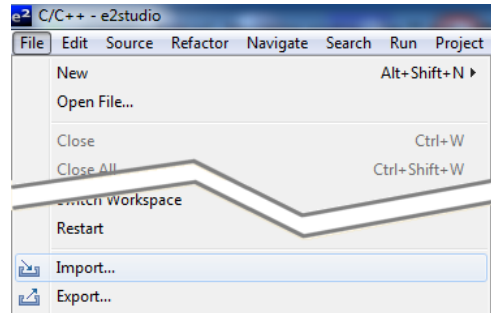
Run e²studio by clicking the Windows Start button, select All Programs > Renesas Electronics e2studio > Renesas e2studio. Choose a workspace folder.



This will automatically open e²studio IDE with an empty workspace



To add the sample code select from the menu bar File > Import as shown:



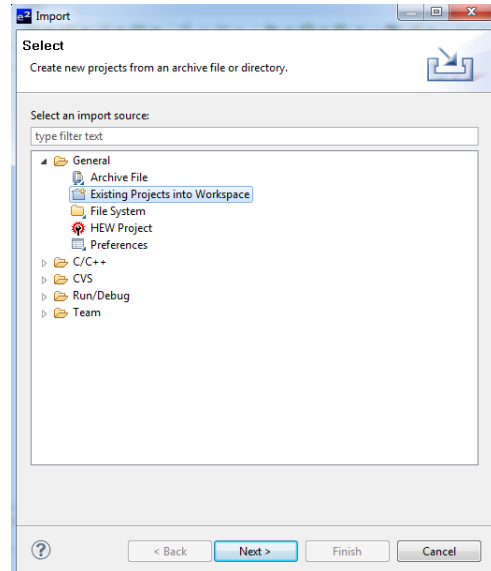
Choose 'Existing Projects into Workspace' as shown:

Click Next >, a new window will appear. Navigate to the RSKRL78G13_Workspace folder and select the ADC_OneShot folder.

Make sure that 'Copy projects into workspace' is checked.

Single-click the project file to select it.

Click < Finish > to add the project to the workspace.



3. Opening Sample Code and Source Files

Once the project has been added, the source code and all dependant files can be opened in the editor by expanding the folders in the Project Explorer window and double clicking the files in the folders. Each source file listed in Workspace window in e²studio can be expanded to reveal its dependant files ; as well as the output files.

In the Project Explorer sidebar, right-click on the project's name and select Build Configurations > Set Active > HardwareDebug. This ensures that the best debug experience will be made available when trying this sample.

4. Source Code

The source code project is specifically written to run on the appropriate RSK. However this source code can be useful as an example even without the RSK.

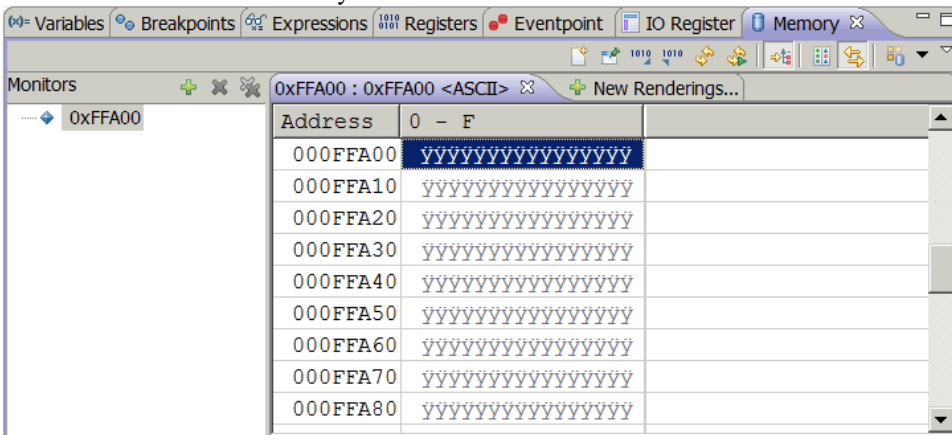
The project was written using source files containing API functions generated using Applilet. The project will contain a C source file 'r_main.c'. This source file will include the C function main(). All source files and dependant files whose filenames are prefixed with 'r_' were generated using Applilet.

5. Code Execution

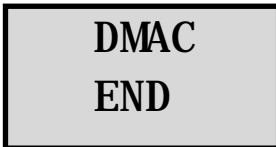
1. Compile the sample code by clicking on the 'Build Project' button on the debug toolbar. Click the 'Debug' button to switch in to a debug perspective. Click the 'Resume' button to start program execution. Click again if the program stops at main(). Instructions will be displayed on the LCD.



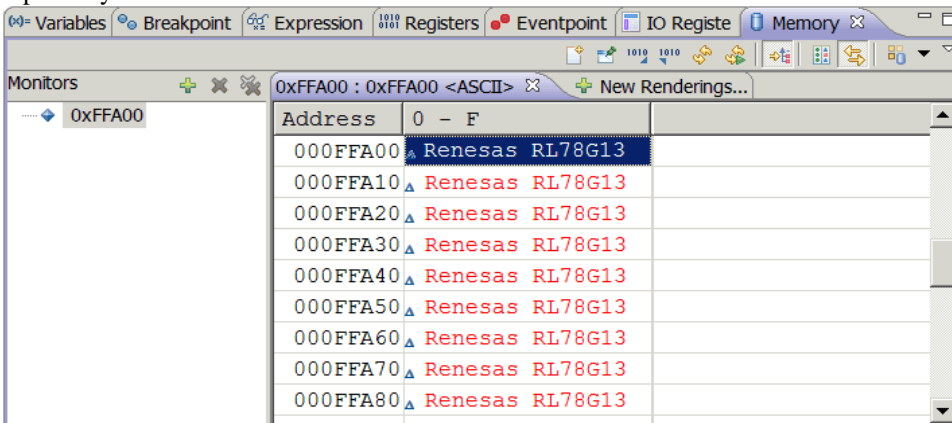
2. Open the memory window by selecting Window > Show View > Memory from the menu bar. Select rendering 'ASCII' and click the Add Rendering(s) button. By default the data is grouped in 4 bytes. To change to 16 bytes, right-click in the memory area and select Format... Set the row and column sizes to 16 unit(s). Observe the contents of memory 0xFFA00 to 0xFFBFF:



3. All user LEDs will remain turned off. Press SW1 to start the data transfer.
4. After a successful transfer, the debug LCD will be updated to inform the user that the transfer is complete.



5. Stop program execution by clicking on the 'Suspend' button. Observe that memory range 0xFFA00 to 0xFFBFF has been filled with the string "Renesas RL78G13 ", repeatedly:



6. Website, Inquiries and Support

Renesas Electronics Website

<http://www.renesas.com/>

Inquiries

<http://www.renesas.com/contact/>

7. Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Jun 7, 2013	—	Original document updated for e ² studio IDE and GNURL78 v13.01 toolchain

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

- Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.
 - The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

- The state of the product is undefined at the moment when power is supplied.
 - The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 - In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
 - In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

- Access to reserved addresses is prohibited.
 - The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

- After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.
 - When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

- Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.
 - The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.

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